

# **Product Change Notification - ASER-15HSFK728**

### Date:

12 Jun 2020 Product Category: Broadband Gateway Affected CPNs:

#### **7**

#### Notification subject:

CCB 3886, 3886.001, and 3886.002 Final Notice: Qualification of MMT as an additional assembly site for selected Microsemi products available in 64L VQFN (9x9x1.0mm), 56L VQFN (8x8x1.0mm), & 40L VQFN (6x6x1.0mm) packages.

#### Notification text:

PCN Status:

Final notification.

PCN Type: Manufacturing Change

# **Microchip Parts Affected:**

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

#### **Description of Change:**

Qualification of MMT as an additional assembly site for selected Microsemi products available in 64L VQFN (9x9x1.0mm), 56L VQFN (8x8x1.0mm), & 40L VQFN (6x6x1.0mm) packages.

# Pre Change:

Assembled at ASEM using PdCu bond wire, CRM1076DS die attach, and CEL-9240HF10AK-G1 mold compound material or assembled at UNIC using CuPdAu bond wire, 8290 die attach, and G770HP mold compound material.

#### **Post Change:**

Assembled at ASEM using PdCu bond wire, CRM1076DS die attach, and CEL-9240HF10AK-G1 mold compound material, assembled at UNIC using CuPdAu bond wire, 8290 die attach, and G770HP mold compound material, or assembled at MMT using CuPdAu wire material, 3280 die attach, and G700LTD mold compound material.

# Pre and Post Change Summary:

	Pre C	hange		Post Change					
Assembly Site	ASE Group - Malaysia (ASEM)	Unisem Chengdu Co.,Ltd. (UNIC)	ASE Group - Malaysia (ASEM)	Unisem Chengdu Co.,Ltd. (UNIC)	Microchip Technology Thailand (Branch) (MMT)				



Wire material	PdCu	CuPdAu	PdCu	CuPdAu	CuPdAu	
Die attach material	CRM1076DS	8290	CRM1076DS	8290	3280	
Molding	CEL-		CEL-			
compound	9240HF10AK-	G770HP	9240HF10AK-	G770HP	G700LTD	
material	G1		G1			
Lead frame	C194	C194	C194	C194	C194	
material	0194	0154	0194	0154	0134	

# Impacts to Data Sheet: None Change Impact: None

# **Reason for Change:**

To improve productivity and on-time delivery by qualifying MMT as an additional assembly site.

# **Change Implementation Status:**

In Progress

### **Estimated First Ship Date:**

June 22, 2020 (date code: 2026)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

#### Time Table Summary:

	October 2019					May 2020			June 2020							
Workweek	40	41	42	43	44	>	18	19	20	21	22	23	24	25	26	27
Initial PCN Issue				V												
Date				^												
Qual Report									Х							
Availability									^							
Final PCN Issue Date									Х							
Estimated															Y	
Implementation Date															~	

# Method to Identify Change:

Traceability code

#### **Qualification Report:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

# **Revision History:**

October 24, 2019: Issued initial notification.

**November 22, 2019:** Reissued initial notification. Corrected Pre and Post Change Attachment to accurately reflect the comparison between the different assembly sites.

May 22, 2020: Issued final notification. Attached the qualification report. Provided estimated first ship



#### date to be on June 22, 2020.

**June 12, 2020:** Ressued final notification. Removed MSL changes and packaging information to reflect no change in the MSL. Updated the qualification report to reflect MSL information. Removed Pre and Post change summary as there is no change to packaging.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

### Attachment(s):

PCN\_ASER-15HSFK728\_Qual Report.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

### Terms and Conditions:

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN home page</u> select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

ASER-15HSFK728 - CCB 3886, 3886.001, and 3886.002 Final Notice: Qualification of MMT as an additional assembly site for selected Microsemi products available in 64L VQFN (9x9x1.0mm), 56L VQFN (8x8x1.0mm), & 40L VQFN (6x6x1.0mm) packages.

Affected Catalog Part Numbers (CPN)

LE88262TQC LE88262TQCT LE88266TQC LE88266TQCT LE88286TQC LE88286TQCT ZL88103LDF1 ZL88103LDG1 ZL88601LDF1 ZL88601LDG1 ZL88602LDF1 ZL88602LDG1 ZL88701LDF1 ZL88701LDG1 ZL88702LDF1 ZL88702LDG1 ZL88801LDF1 ZL88801LDG1 LE9661WQC LE9661WQCT LE9662WQC LE9662WQCT LE9672WQC LE9672WQCT ZL88105LDF1 ZL88105LDG1 LE9540CUQC LE9540CUQCT LE9540DUQC LE9540DUQCT LE9541CUQC LE9541CUQCT LE9541DUQC LE9541DUQCT